



MIC5207

180mA Low-Noise LDO Regulator

General Description

The MIC5207 is an efficient linear voltage regulator with ultra-low-noise output, very low dropout voltage (typically 17mV at light loads and 165mV at 150mA), and very low ground current (720 μ A at 100mA output). The MIC5207 offers better than 3% initial accuracy.

Designed especially for hand-held, battery-powered devices, the MIC5207 includes a CMOS or TTL compatible enable/shutdown control input. When in shutdown, power consumption drops nearly to zero.

Key MIC5207 features include a reference bypass pin to improve its already low-noise performance, reversed-battery protection, current limiting, and over temperature shutdown.

The MIC5207 is available in fixed and adjustable output voltage versions in a small SOT-23-5 package. Contact Micrel for details.

For low-dropout regulators that are stable with ceramic output capacitors, see the μ Cap MIC5245/6/7 family.

Datasheets and support documentation are available on Micrel's web site at: www.micrel.com.

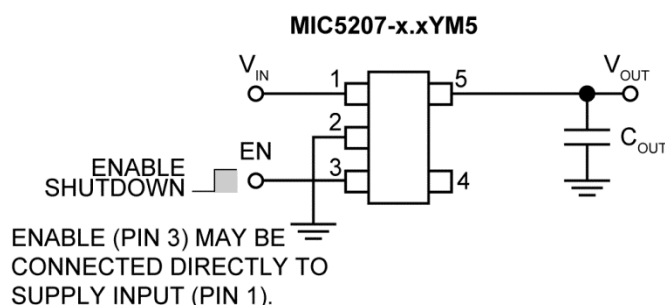
Features

- Output voltage range: 1.8V – 15V
- Ultra-low-noise output
- High output voltage accuracy
- Guaranteed 180mA output
- Low quiescent current
- Low dropout voltage
- Extremely tight load and line regulation
- Very low temperature coefficient
- Current and thermal limiting
- Reversed-battery protection
- "Zero" off-mode current
- Logic-controlled electronic enable

Applications

- Cellular telephones
- Laptop, notebook, and palmtop computers
- Battery-powered equipment
- PCMCIA VCC and VPP regulation/switching
- Consumer/personal electronics
- SMPS post-regulator/dc-to-dc modules
- High-efficiency linear power supplies

Typical Application



Battery-Powered Regulator Application

Ordering Information

| Part Number | Marking ⁽²⁾ | Voltage ⁽¹⁾ | Junction Temp. Range | Package | Lead Finish |
|----------------|------------------------|------------------------|----------------------|-------------------|-------------|
| MIC5207-1.8YD5 | <u>NE</u> 18 | 1.8V | 0° to +125°C | 5-Pin Thin SOT-23 | Pb-Free |
| MIC5207YM5 | <u>LE</u> AA | Adj. (2.5–15.0V) | –40° to +125°C | 5-Pin SOT-23 | Pb-Free |
| | | Adj. (1.8–2.5V) | 0° to +125°C | | |
| MIC5207-1.8YM5 | <u>LE</u> 18 | 1.8V | 0° to +125°C | 5-Pin SOT-23 | Pb-Free |
| MIC5207-2.5YM5 | <u>LE</u> 25 | 2.5V | –40° to +125°C | 5-Pin SOT-23 | Pb-Free |
| MIC5207-2.8YM5 | <u>LE</u> 28 | 2.8V | –40° to +125°C | 5-Pin SOT-23 | Pb-Free |
| MIC5207-2.9YM5 | <u>LE</u> 29 | 2.9V | –40° to +125°C | 5-Pin SOT-23 | Pb-Free |
| MIC5207-3.0YM5 | <u>LE</u> 30 | 3.0V | –40° to +125°C | 5-Pin SOT-23 | Pb-Free |
| MIC5207-3.1YM5 | <u>LE</u> 31 | 3.1V | –40° to +125°C | 5-Pin SOT-23 | Pb-Free |
| MIC5207-3.2YM5 | <u>LE</u> 32 | 3.2V | –40° to +125°C | 5-Pin SOT-23 | Pb-Free |
| MIC5207-3.3YM5 | <u>LE</u> 33 | 3.3V | –40° to +125°C | 5-Pin SOT-23 | Pb-Free |
| MIC5207-3.6YM5 | <u>LE</u> 36 | 3.6V | –40° to +125°C | 5-Pin SOT-23 | Pb-Free |
| MIC5207-3.8YM5 | <u>LE</u> 38 | 3.8V | –40° to +125°C | 5-Pin SOT-23 | Pb-Free |
| MIC5207-4.0YM5 | <u>LE</u> 40 | 4.0V | –40° to +125°C | 5-Pin SOT-23 | Pb-Free |
| MIC5207-5.0YM5 | <u>LE</u> 50 | 5.0V | –40° to +125°C | 5-Pin SOT-23 | Pb-Free |

Note:

- Other voltages available. Contact Micrel for details.
- Under bar () symbol may not be to scale.

Pin Configuration



Pin Description

| Pin Number SOT-23-5 | Pin Name | Pin Name |
|------------------------|----------|---|
| 1 | IN | Supply Input. |
| 2 | GND | Ground. |
| 3 | EN | Enable/Shutdown (Input): CMOS compatible input. Logic high = enable, logic low = shutdown. Do not leave floating. |
| 4 (fixed) | BYP | Reference Bypass: Connect external 470pF capacitor to GND to reduce output noise. May be left open. For 1.8V or 2.5V operation, see "Applications Information". |
| 4 (adj.) | ADJ | Adjust (Input): Adjustable regulator feedback input. Connect to resistor voltage divider. |
| 5 | OUT | Regulator Output. |

Absolute Maximum Ratings⁽³⁾

| | |
|-------------------------------------|-----------------------------------|
| Supply Input Voltage (V_{IN}) | –20V to +20V |
| Enable Input Voltage (V_{EN}) | –20V to +20V |
| Power Dissipation (P_D) | Internally Limited ⁽⁵⁾ |
| Lead Temperature (soldering, 5 sec) | 260°C |
| Junction Temperature (T_J) | |
| All except 1.8V | –40°C to +125°C |
| 1.8V ONLY | 0°C to +125°C |
| Storage Temperature (T_S) | –65°C to +150°C |

Operating Ratings⁽⁴⁾

| | |
|---|-----------------|
| Supply Input Voltage (V_{IN}) | +2.5V to +16V |
| Adjustable Output Voltage (V_{OUT}) Range | 1.8V to 15V |
| Enable Input Voltage (V_{EN}) | 0V to V_{IN} |
| Junction Temperature (T_J) | |
| $2.5 \leq V_{OUT} \leq 15V$ | –40°C to +125°C |
| $1.8V \leq V_{OUT} < 2.5V$ | 0°C to +125°C |
| Thermal Resistance (θ_{JA}) | Note 5 |

Electrical Characteristics

$V_{IN} = V_{OUT} + 1V$; $I_L = 100\mu A$; $C_L = 1.0\mu F$; $V_{EN} \geq 2.0V$; $T_J = 25^\circ C$, **bold** values indicate $-40^\circ C < T_J < +125^\circ C$ except $0^\circ C < T_J < +125^\circ C$ for 1.8V, unless noted.

| Symbol | Parameter | Condition | Min | Typ | Max | Units |
|-------------------------|--|--|----------|-------------------------|--|----------------------------------|
| V_O | Output Voltage Accuracy | Variation from nominal V_{OUT} | –3 –4 | | 3 4 | % % |
| $\Delta V_O / \Delta T$ | Output Voltage Temperature Coefficient | Note 6 | | 40 | | ppm/°C |
| $\Delta V_O / V_O$ | Line Regulation | $V_{IN} = V_{OUT} + 1V$ to 16V | | 0.005 | 0.05 0.10 | %/V %/V |
| $\Delta V_O / V_O$ | Load Regulation | $I_L = 0.1mA$ to 150mA, Note 7 | | 0.05 | 0.5 0.7 | % % |
| $V_{IN} - V_O$ | Dropout Voltage, Note 8 | $I_L = 100\mu A$ $I_L = 50mA$ $I_L = 100mA$ $I_L = 150mA$ | | 17 115 140 165 | 60 80 175 280 325 300 400 | mV mV mV mV mV mV |
| I_{GND} | Quiescent Current | $V_{EN} \leq 0.4V$ (shutdown) $V_{EN} \leq 0.18V$ (shutdown) | | 0.01 | 1 5 | μA μA |

Notes:

- Exceeding the absolute maximum rating may damage the device.
- The device is not guaranteed to function outside its operating rating.
- The maximum allowable power dissipation at any T_A (ambient temperature) is $P_D(max) = (T_J(max) - T_A) / \theta_{JA}$. Exceeding the maximum allowable power dissipation will cause excessive die temperature, and the regulator will go into thermal shutdown. The θ_{JA} of the SOT-23-5 (M5) is 235°C/W soldered on a PC board (see “Thermal Considerations” for further details).
- Output voltage temperature coefficient is defined as the worst case voltage change divided by the total temperature range.
- Regulation is measured at constant junction temperature using low duty cycle pulse testing. Parts are tested for load regulation in the load range from 0.1mA to 180mA. Changes in output voltage due to heating effects are covered by the thermal regulation specification.
- Dropout Voltage is defined as the input to output differential at which the output voltage drops 2% below its nominal value measured at 1V differential.

Electrical Characteristics (Continued)

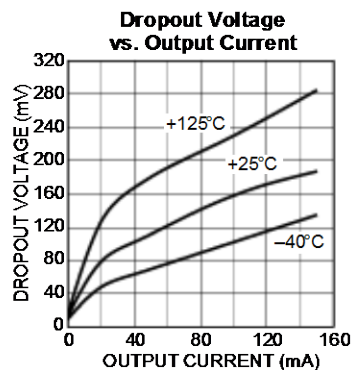
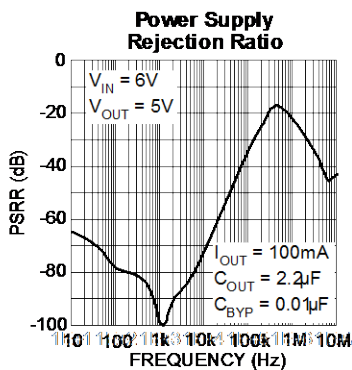
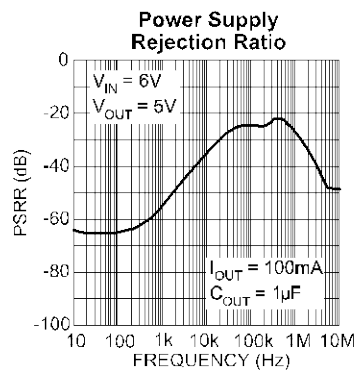
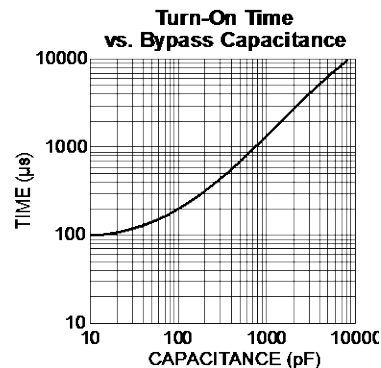
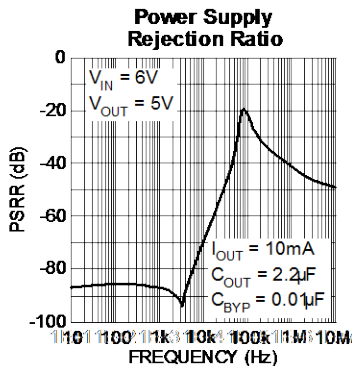
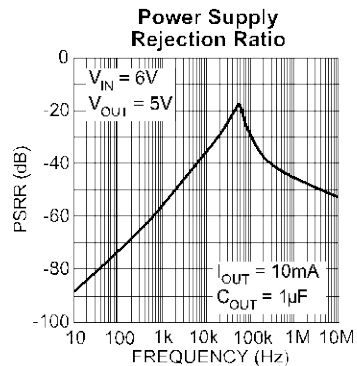
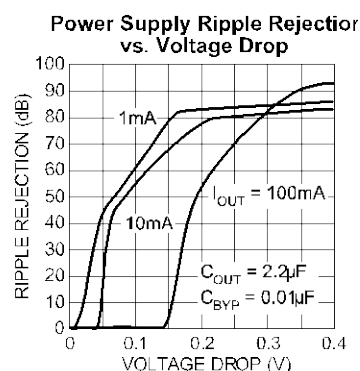
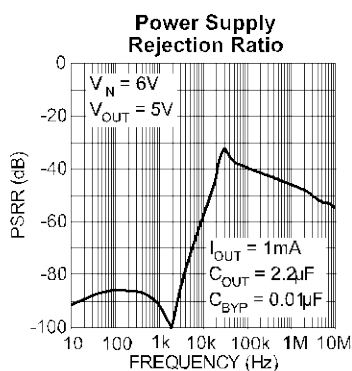
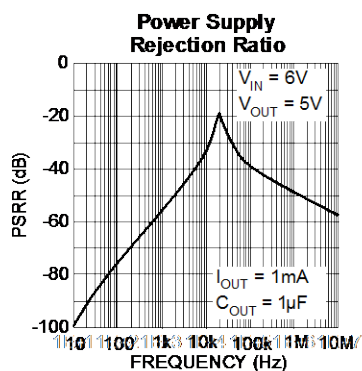
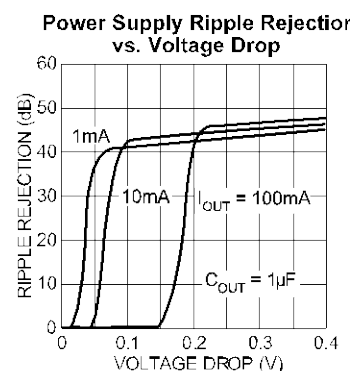
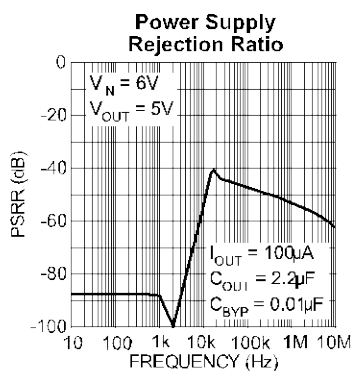
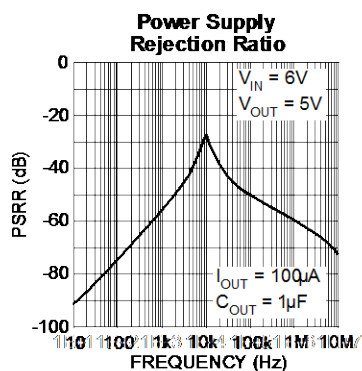
$V_{IN} = V_{OUT} + 1V$; $I_L = 100\mu A$; $C_L = 1.0\mu F$; $V_{EN} \geq 2.0V$; $T_J = 25^\circ C$, bold values indicate $-40^\circ C < T_J < +125^\circ C$ except $0^\circ C < T_J < +125^\circ C$ for 1.8V, unless noted.

| Symbol | Parameter | Condition | Min | Typ | Max | Units |
|---------------------------|--|---|------------|--------------------------------------|--|---|
| I_{GND} | Ground Pin Current, Note 9 | $V_{EN} \geq 2.0V$, $I_L = 100\mu A$ $I_L = 50mA$ $I_L = 100mA$ $I_L = 150mA$ | | 80 350 720 1800 | 130 170 650 900 1100 2000 2500 3000 | μA μA μA μA μA μA μA |
| PSRR | Ripple Rejection | | | 75 | | dB |
| I_{LIMIT} | Current Limit | $V_{OUT} = 0V$ | | 320 | 500 | mA |
| $\Delta V_O / \Delta P_D$ | Thermal Regulation | Note 10 | | 0.05 | | %/W |
| e_{no} | Output Noise | $I_L = 50mA$, $C_L = 2.2\mu F$, 470pF from BYP to GND | | 260 | | nV \sqrt{Hz} |
| Enable Input | | | | | | |
| V_{IL} | Enable Input Logic-Low Voltage | Regulator shutdown | | | 0.4 0.18 | V V |
| V_{IH} | Enable Input Logic-High Voltage | Regulator enable | 2.0 | | | V |
| I_{IL} I_{IH} | Enable Input Current | $V_{IL} \leq 0.4V$ $V_{IL} \leq 0.18V$ $V_{IH} \geq 2.0V$ $V_{IH} \geq 2.0V$ | | 0.01 5 | -1 -2 20 25 | μA μA μA μA |

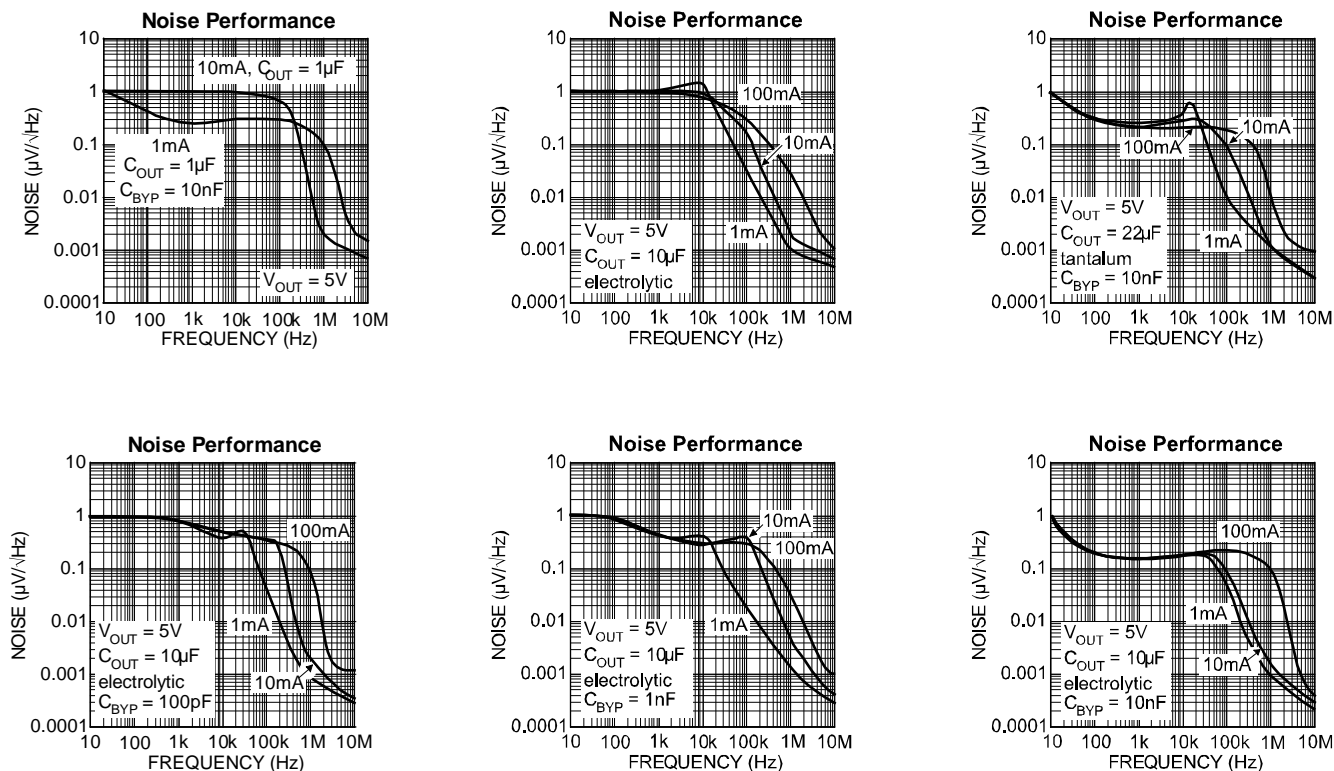
Notes:

- Ground pin current is the regulator quiescent current plus pass transistor base current. The total current drawn from the supply is the sum of the load current plus the ground pin current.
- Thermal regulation is defined as the change in output voltage at a time "t" after a change in power dissipation is applied, excluding load or line regulation effects. Specifications are for a 180mA load pulse at $V_{IN} = 16V$ for $t = 10ms$.

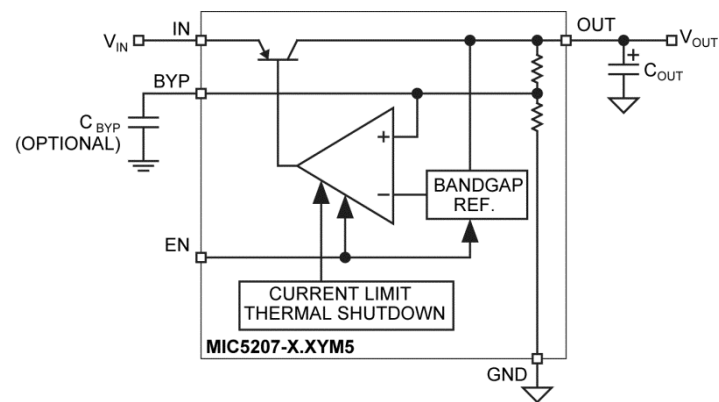
Typical Characteristics



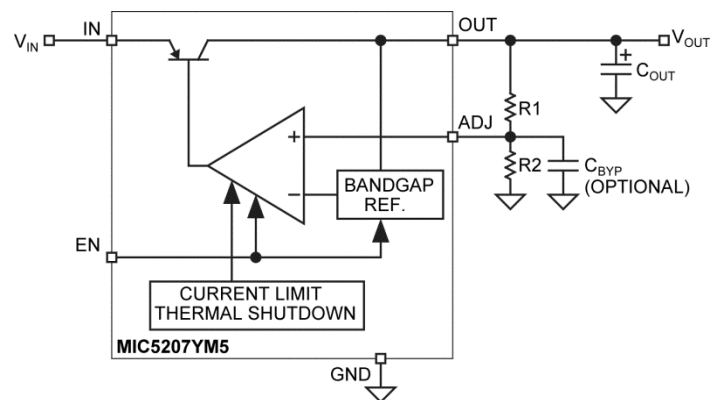
Typical Characteristics (Continued)



Block Diagrams



Ultra-Low-Noise Fixed Regulator



Ultra-Low-Noise Adjustable Regulator

Application Information

Enable/Shutdown

Forcing EN (enable/shutdown) high (> 2V) enables the regulator. EN is compatible with CMOS logic gates.

If the enable/shutdown feature is not required, connect EN (pin 3) to IN (supply input, pin 1). See Figure 1.

Input Capacitor

A 1μF capacitor should be placed from IN to GND if there is more than 10 inches of wire between the input and the ac filter capacitor or if a battery is used as the input.

Reference Bypass Capacitor

BYP (reference bypass) is connected to the internal voltage reference. A 470pF capacitor (C_{BYP}) connected from BYP to GND quiets this reference, providing a significant reduction in output noise. C_{BYP} reduces the regulator phase margin; when using C_{BYP} , output capacitors of 2.2μF or greater are generally required to maintain stability.

The start-up speed of the MIC5207 is inversely proportional to the size of the reference bypass capacitor. Applications requiring a slow ramp-up of output voltage should consider larger values of C_{BYP} . Likewise, if rapid turn-on is necessary, consider omitting C_{BYP} .

If output noise is not a major concern, omit C_{BYP} and leave BYP open.

Output Capacitor

An output capacitor is required between OUT and GND to prevent oscillation. The minimum size of the output capacitor is dependent upon whether a reference bypass capacitor is used. 1.0μF minimum is recommended when C_{BYP} is not used (see Figure 2). 2.2μF minimum is recommended when C_{BYP} is 470pF (see Figure 1). Larger values improve the regulator's transient response. The output capacitor value may be increased without limit.

The output capacitor should have an ESR (effective series resistance) of about 5Ω or less and a resonant frequency above 1MHz. Ultra-low-ESR (ceramic) capacitors can cause a low amplitude oscillation on the output and/or under-damped transient response. Most tantalum or aluminum electrolytic capacitors are adequate; film types will work, but are more expensive. Since many aluminum electrolytics have electrolytes that freeze at about -30°C, solid tantalums are recommended for operation below -25°C.

At lower values of output current, less output capacitance is required for output stability. The capacitor can be reduced to 0.47μF for current below 10mA or 0.33μF for currents below 1mA.

No-Load Stability

The MIC5207 will remain stable and in regulation with no load (other than the internal voltage divider) unlike many other voltage regulators. This is especially important in CMOSRAM keep-alive applications.

Thermal Considerations

The MIC5207 is designed to provide 180mA of continuous current in a very small package. Maximum power dissipation can be calculated based on the output current and the voltage drop across the part. To determine the maximum power dissipation of the package, use the junction-to-ambient thermal resistance of the device and the following basic equation shown in [Equation 1](#):

$$P_{D(MAX)} = \frac{(T_{J(MAX)} - T_A)}{\theta_{JA}} \quad \text{Eq. 1}$$

$T_{J(max)}$ is the maximum junction temperature of the die, 125°C, and T_A is the ambient operating temperature. θ_{JA} is layout dependent; Table 1 shows examples of junction-to-ambient thermal resistance for the MIC5207.

Table 1. SOT-23-5 Thermal Resistance

| Package | θ_{JA} Recommended Minimum Footprint | θ_{JA} 1" Square Copper Clad | θ_{JC} |
|---------------|---|-------------------------------------|---------------|
| SOT-23-5 (M5) | 235°C/W | 170°C/W | 130°C/W |

The actual power dissipation of the regulator circuit can be determined using [Equation 2](#):

$$P_D = (V_{IN} - V_{OUT}) I_{OUT} + V_{IN} I_{GND} \quad \text{Eq. 2}$$

Substituting $P_{D(max)}$ for P_D and solving for the operating conditions that are critical to the application will give the maximum operating conditions for the regulator circuit. For example, when operating the MIC5207-3.3YM5 at room temperature with a minimum footprint layout, the maximum input voltage for a set output current can be determined with [Equation 3](#):

$$P_{D(MAX)} = \frac{125^\circ\text{C} - 25^\circ\text{C}}{235^\circ\text{C/W}} \quad \text{Eq. 3}$$

$$P_{D(MAX)} = 425\text{mW}$$

The junction-to-ambient thermal resistance for the minimum footprint is 235°C/W, from Table 1. The maximum power dissipation must not be exceeded for proper operation. Using the output voltage of 3.3V and an output current of 150mA, the maximum input voltage can be determined. From the [Electrical Characteristics](#) table, the maximum ground current for 150mA output current is 3000μA or 3mA.

$$455\text{mW} = (V_{\text{IN}} - 3.3\text{V})150\text{mA} + V_{\text{IN}} \cdot 3\text{mA}$$

$$455\text{mW} = V_{\text{IN}} \cdot 150\text{mA} - 495\text{mW} + V_{\text{IN}} \cdot 3\text{mA}$$

$$920\text{mW} = V_{\text{IN}} \cdot 153\text{mA}$$

$$V_{\text{IN(MAX)}} = 6.01\text{V}$$

Therefore, a 3.3V application at 150mA of output current can accept a maximum input voltage of 6V in a SOT-23-5 package. For a full discussion of heat sinking and thermal effects on voltage regulators, refer to the Regulator Thermals section of Micrel's *Designing with Low-Dropout Voltage Regulators* handbook

Low-Voltage Operation

The MIC5207-1.8 and MIC5207-2.5 require special consideration when used in voltage-sensitive systems. They may momentarily overshoot their nominal output voltages unless appropriate output and bypass capacitor values are chosen.

During regulator power up, the pass transistor is fully saturated for a short time, while the error amplifier and voltage reference are being powered up more slowly from the output (see [Block Diagrams](#)). Selecting larger output and bypass capacitors allows additional time for the error amplifier and reference to turn on and prevent overshoot.

To ensure that no overshoot is present when starting up into a light load (100μA), use a 4.7μF output capacitance and 470pF bypass capacitance. This slows the turn-on enough to allow the regulator to react and keep the output voltage from exceeding its nominal value. At heavier loads, use a 10μF output capacitance and 470pF bypass capacitance. Lower values of output and bypass capacitance can be used, depending on the sensitivity of the system.

Applications that can withstand some overshoot on the output of the regulator can reduce the output capacitor and/or reduce or eliminate the bypass capacitor. Applications that are not sensitive to overshoot due to power-on reset delays can use normal output and bypass capacitor configurations.

Please note the junction temperature range of the regulator with an output less than 2.5V fixed and adjustable is 0°C to +125°C.

Fixed Regulator Applications

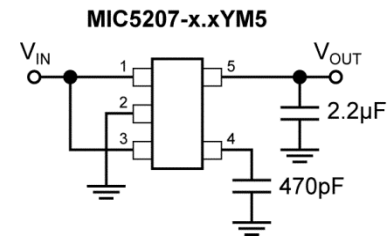


Figure 1. Ultra-Low-Noise Fixed Voltage Application

Figure 1 includes a 470pF capacitor for ultra-low-noise operation and shows EN (pin 3) connected to IN (pin 1) for an application where enable/shutdown is not required. $C_{\text{OUT}} = 2.2\mu\text{F}$ minimum.

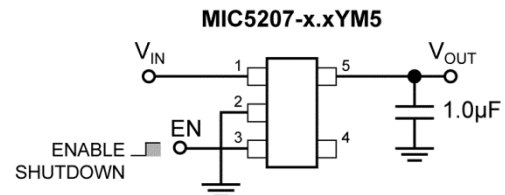


Figure 2. Low-Noise Fixed Voltage Application

Figure 2 is an example of a basic low-noise configuration. $C_{\text{OUT}} = 1\mu\text{F}$ minimum.

Adjustable Regulator Applications

The MIC5207YM5 can be adjusted to a specific output voltage by using two external resistors (Figure 3). The resistors set the output voltage based on Equation 4:

$$V_{\text{OUT}} = V_{\text{REF}} \left(1 + \frac{R_2}{R_1} \right), V_{\text{REF}} = 1.242\text{V} \quad \text{Eq. 4}$$

This equation is correct due to the configuration of the bandgap reference. The bandgap voltage is relative to the output, as seen in the [Block Diagrams](#). Traditional regulators normally have the reference voltage relative to ground; therefore, their equations are different from the equation for the MIC5207YM5.

Resistor values are not critical because ADJ (adjust) has a high input impedance, but for best results use resistors of 470kΩ or less. A capacitor from ADJ to ground provides greatly improved noise performance.

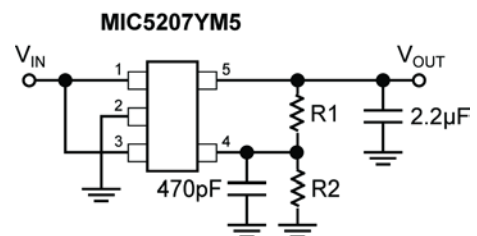


Figure 3. Ultra-Low-Noise Adjustable Voltage Application

Figure 3 includes the optional 470pF noise bypass capacitor from ADJ to GND to reduce output noise.

Dual-Supply Operation

When used in dual-supply systems where the regulator load is returned to a negative supply, the output voltage must be diode clamped to ground.

USB Application

Figure 4 shows the MIC5207-3.3YM5 in a USB application. Since the V_{BUS} supply may be greater than 10 inches from the regulator, a $1\mu\text{F}$ input capacitor is included.

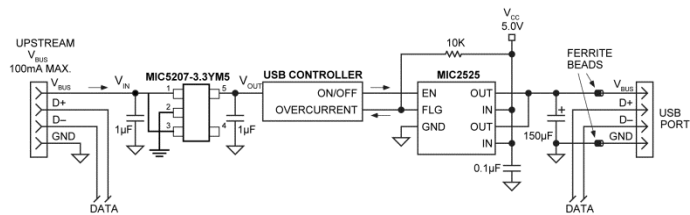
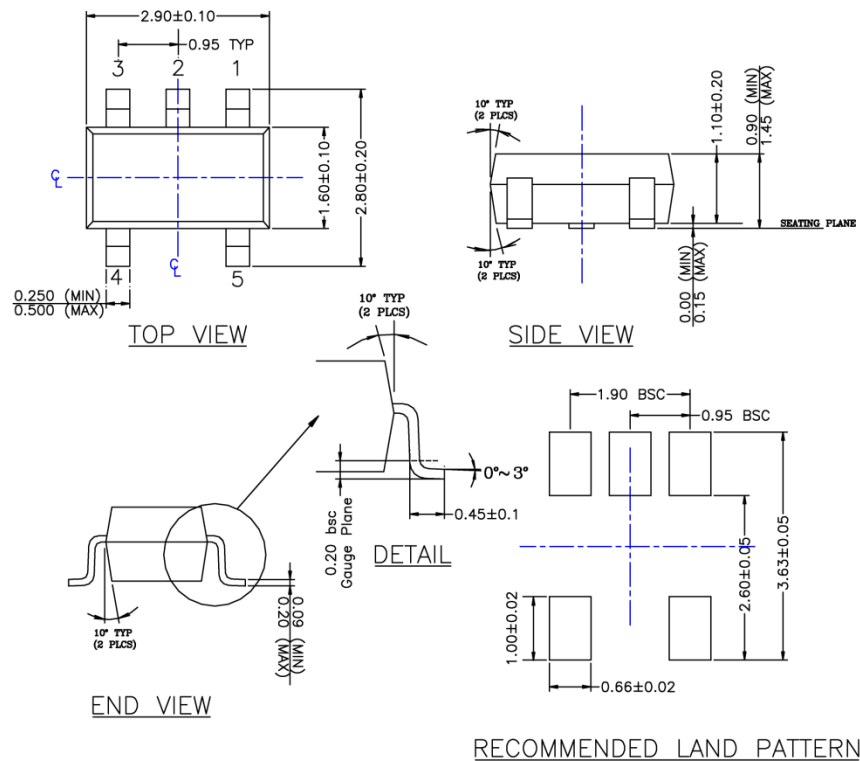


Figure 4. Single-Port Self-Powered Hub

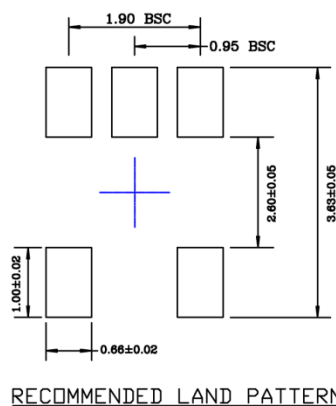
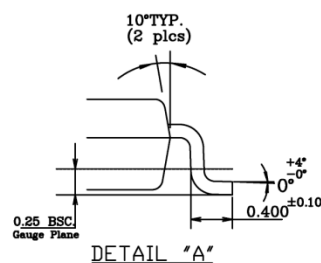
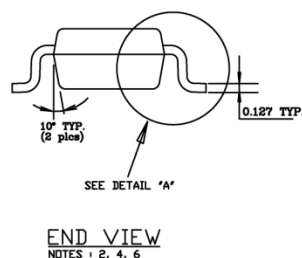
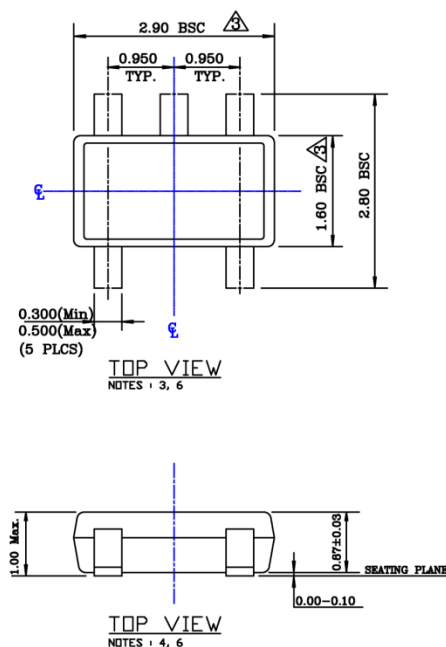
Package Information⁽¹¹⁾



- NOTE:
1. PACKAGE OUTLINE EXCLUSIVE OF MOLD FLASH & BURR.
 2. PACKAGE OUTLINE INCLUSIVE OF SOLDER PLATING.
 3. DIMENSION AND TOLERANCE PER ANSI Y14.5M, 1982.
 4. FOOT LENGTH MEASUREMENT BASED ON GAUGE PLANE METHOD.
 5. DIE FACES UP FOR MOLD, AND FACES DOWN FOR TRIM/FORM.
 6. ALL DIMENSIONS ARE IN MILLIMETERS.

5-Pin SOT-23 (M5)

Package Information⁽¹¹⁾ (Continued)



NOTE:

1. Dimensions and tolerances are as per ANSI Y14.5M, 1994.
2. Die is facing up for mold. Die is facing down for trim/form, ie. reverse trim/form.
3. Dimensions are exclusive of mold flash and gate burr.
4. The footlength measuring is based on the gauge plane method.
5. All specification comply to Jedec Spec M0193 Issue C.
6. All dimensions are in millimeters.

5-Pin Thin SOT-23 (D5)

Note:

11. Package information is correct as of the publication date. For updates and most current information, go to www.micrel.com.

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